TUSB522P EVM

This is the user guide for the evaluation module (EVM) of the TUSB522P. The purpose of this user guide is to facilitate an easy evaluation process of the TUSB522P USB 3.1 SuperSpeed (5 Gbps) Re-Driver.

The contents of this user's guide are meant to provide an overview of the TUSB522P, including the key features, operating conditions, and how to setup this EVM for use in a system level evaluation.

The construction of the TUSB522P EVM also serves as a reference design that can be easily modified for any intended application. Target applications include cell phones, computers, docking stations, TVs, and active cables. Schematic and layout information is included at the end of this manual.

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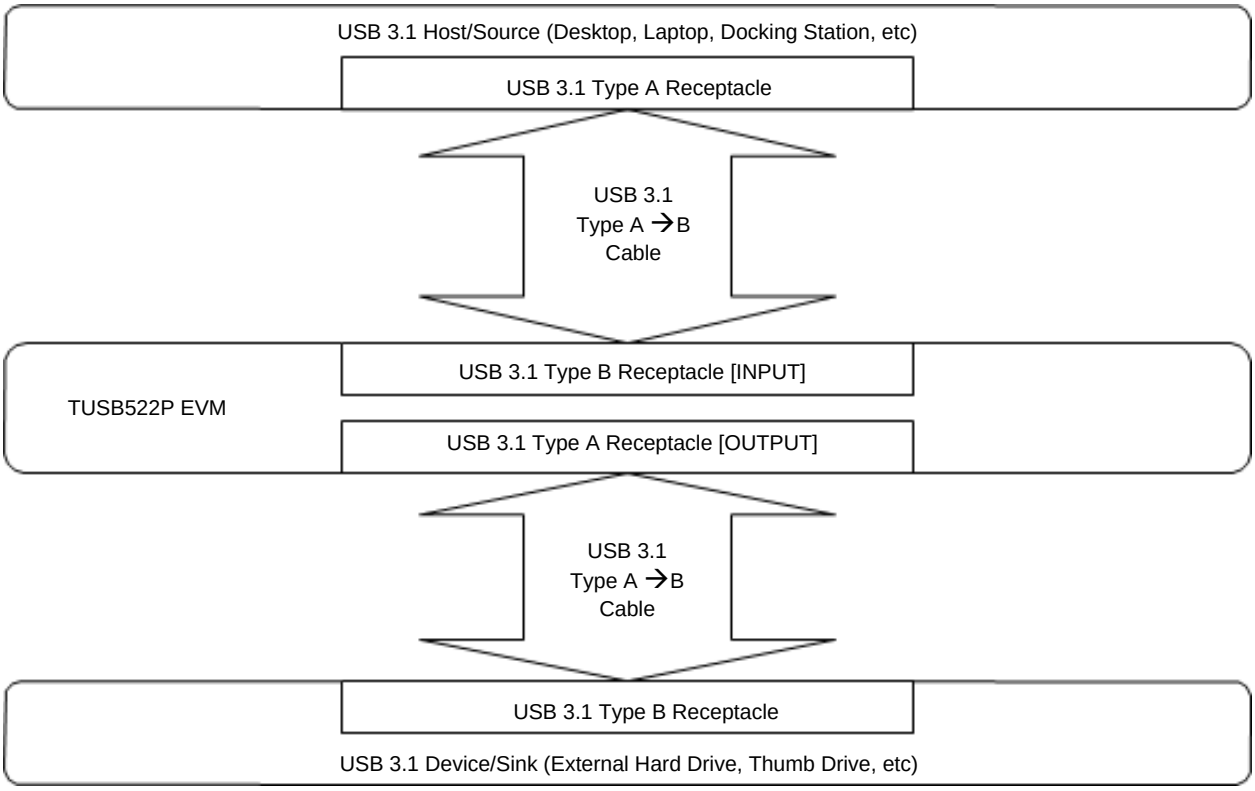
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1 Introduction

The TUSB522P is a dual channel, USB 3.1 SuperSpeed re-driver and signal conditioner supporting data rates of 5.0 Gbps. The device complies with USB 3.1 spec revision 1.0, supporting electrical idle condition and low frequency periodic signals (LFPS) for USB 3.1 power management modes.

The device offers programmable equalization that extends the interconnect distance between two devices. Also, the device supports low power modes when unplugged. The device can also function in USB compliance mode to test the transmitter for compliance to voltage and timing specifications per USB 3.1 compliance specs.

This EVM was designed to be used as a medium connection between a USB host and a USB device. The interface to the EVM consists of a USB 3.1 Type A Receptacle and a USB 3.1 Type B Receptacle. Therefore, in order to connect the EVM to your system set up, the user will most likely need 2 USB 3.1 Standard Type AM B cables. Your test setup should look similar to Figure 1.



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Figure 1. TUSB522P Functional System Level Block Diagram

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2 TUSB522P EVM Configuration

This EVM kit should contain the following items:

- TUSB522P EVM board
- This user's manual

2.1 Description of EVM Board

The TUSB522P EVM is designed to provide easy evaluation of the TUSB522P device. It is also meant to serve as a reference design to show a practical example of how to use the device in a mass-production system. Figure 2 highlights the jumpers and switch installed on this EVM and Table 1 highlights their functionality and configuration.

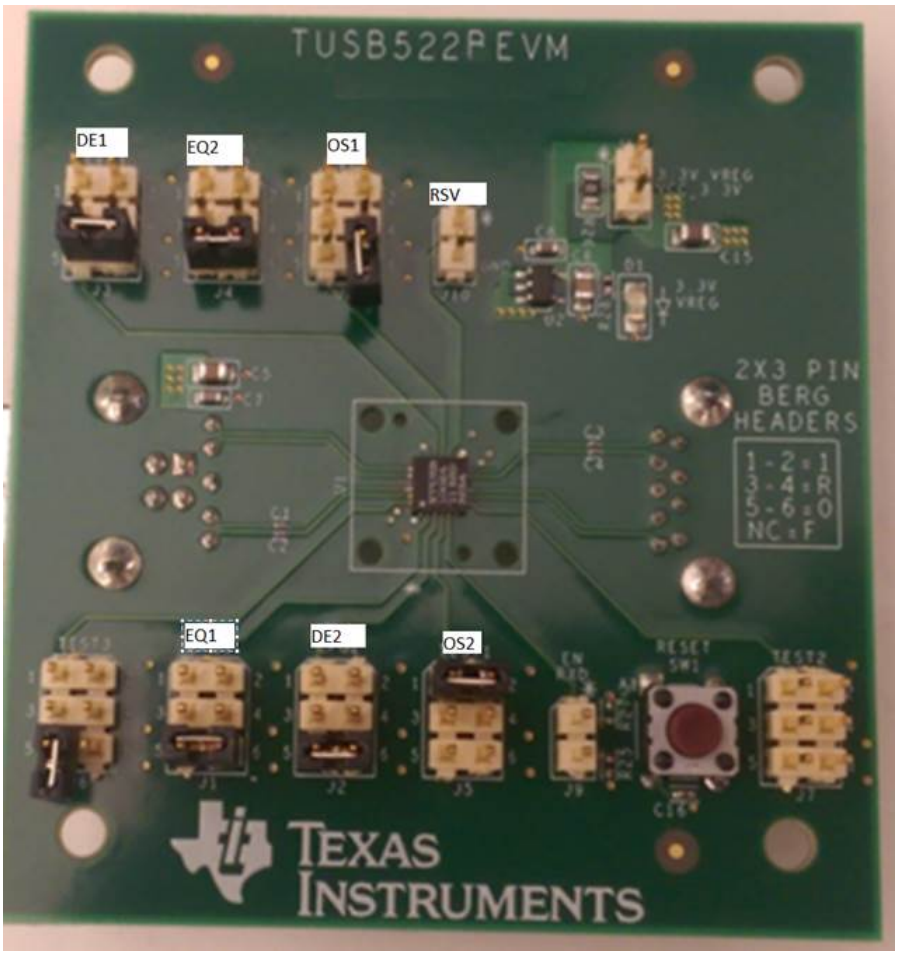


Figure 2. EVM (Top Side)

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Table 1. Jumper / Switch Description and Settings

Jumper	Functionality and Configuration
J1	EQ1 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J2	DE2 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J3	DE1 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J4	EQ2 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J5	OS2 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J6	NC2 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J7	NC1 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J8	OS1 1-2 = 1 (1K to VCC) 3-4 = R (20K to GND) 5-6 = 0 (1K to GND) NC = F (No Connect)
J9/SW1	EN_RXD (Shutdown Mode) 1-2 = 1K to GND NC = Internal Pull-up (Default) SW1 = Push to Short EN to GND
J10	RSVD 1-2 = 1K to GND NC = Internal Pull-up (Default)
J11	VCC 3.3V 1-2 = VCC_3.3V Provided from U2 (Default) NC = Provide external 3.3 V on Pin 2

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2.2 TUSB522P Configuration Pins

The equalization, output swing amplitude, and de-emphasis levels of each channel are configured via EQ, DE and OS pin states. Table 2 through Table 4 list all possible levels that can be achieved with the TUSB522P.

Table 2. TUSB522P Equalization Selection Table

Equalization Level	
EQx Pin Level	**EQ Gain at 2.5 GHz (dB)**
Low	3
Floating	6
High	9

Table 3. TUSB522P Output Swing Amplitude

Equalization Level	
OSx Pin Level	**Transition Bit Output Differential Voltage (mV)**
Low	900
High	1200

Table 4. TUSB522P De-Emphasis

DEx	De-Emphasis Ratio (dB)	
	OS = Low	**OS = High**
Low	0	–2.6
Floating	–3.5	–5.9
High	–6.2	–8.3

2.3 Monitoring the Device Current

The TUSB522P EVM includes the option of monitoring the current draw of the device. In order to enable this feature, the following steps must be taken:

1. Un-install the shunt located at JMP11 and remove R26.
2. Obtain a power supply with the ability to display its current draw (or connect a current meter in series to the power supply)
3. Connect to 3.3 V of external power source to VCC_3.3V (J11-2) and GND of the external supply to a convenient GND location on the EVM (J10-2).
4. Turn on your power supply and observe the measured current on your power supply display (or current meter)

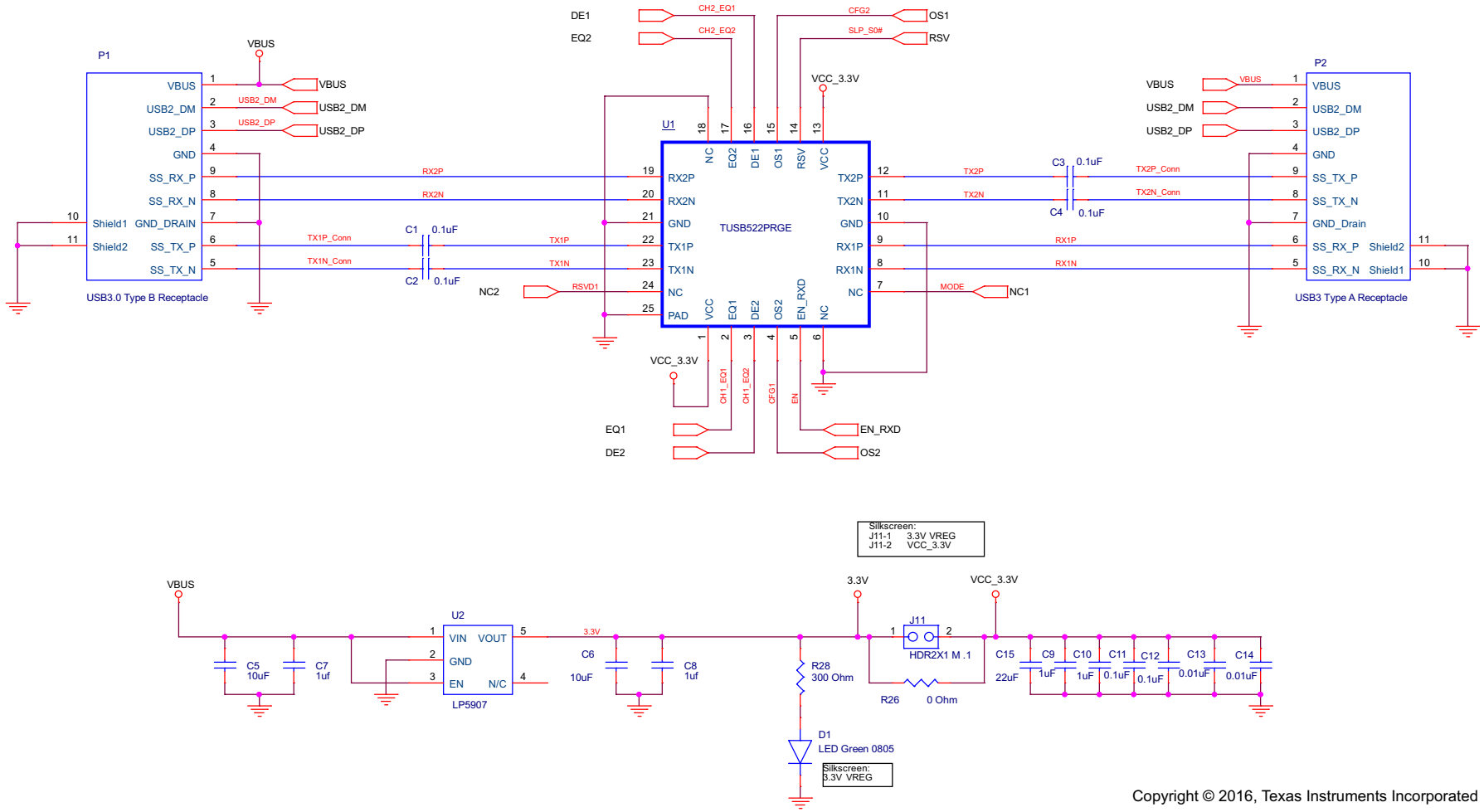
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3 PCB Construction

This section discusses the construction of the EVM boards. It includes the board schematics and layout files to show how the board was built.

3.1 TUSB522P EVM Board Schematics

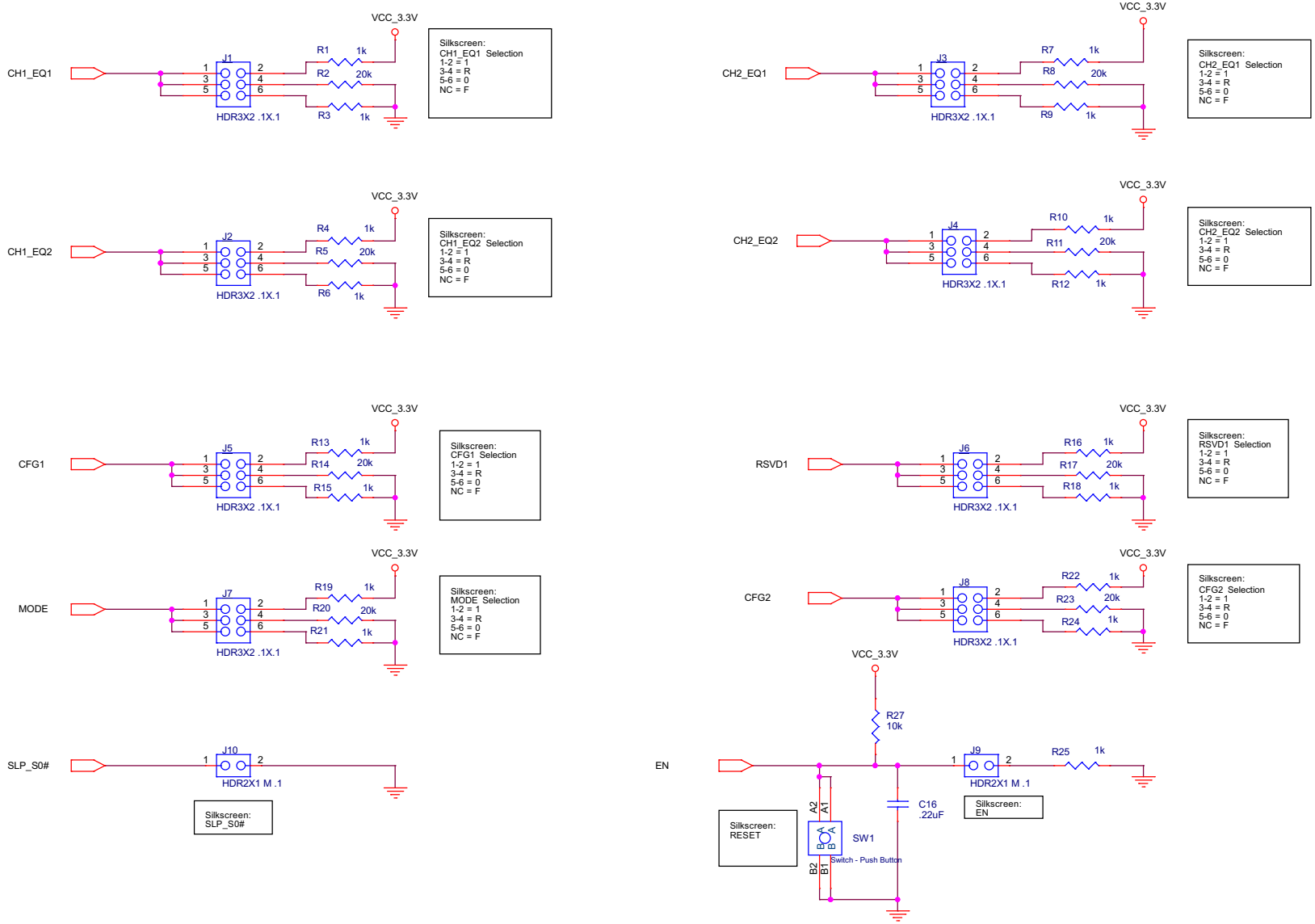
Figure 3 and Figure 4 illustrate the EVM schematics.



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Figure 3. TUSB522P EVM Schematic (High Speed Pins / Power)

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Figure 4. TUSB522P EVM Schematic (Device Control Pins)

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3.2 TUSB522P EVM Board Layout

This EVM was designed to show the implementation on a 4-layer board. Figure 5 through Figure 8 display the EVM PCB board layout.

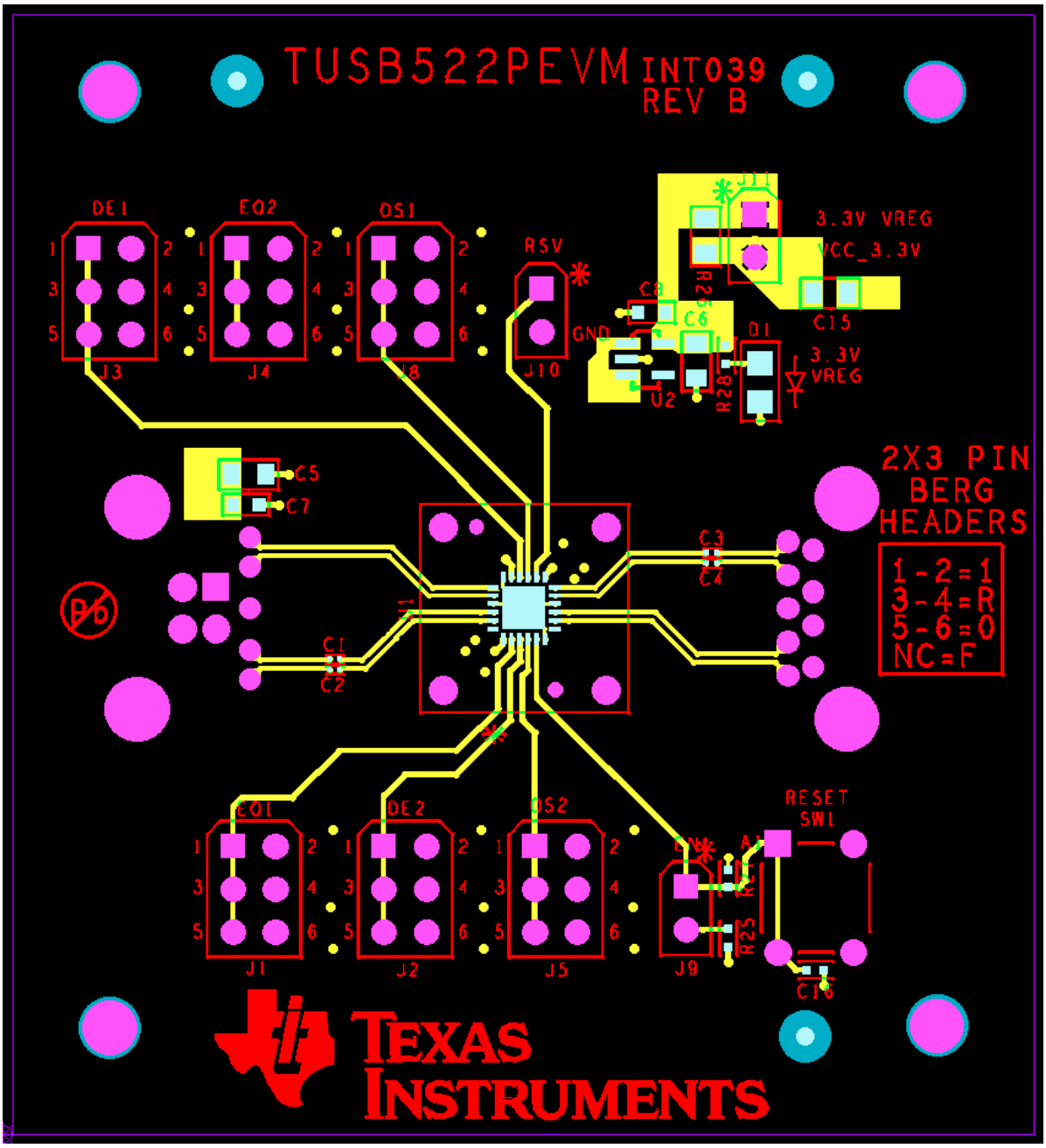


Figure 5. EVM Layout Layer 1 (Top)

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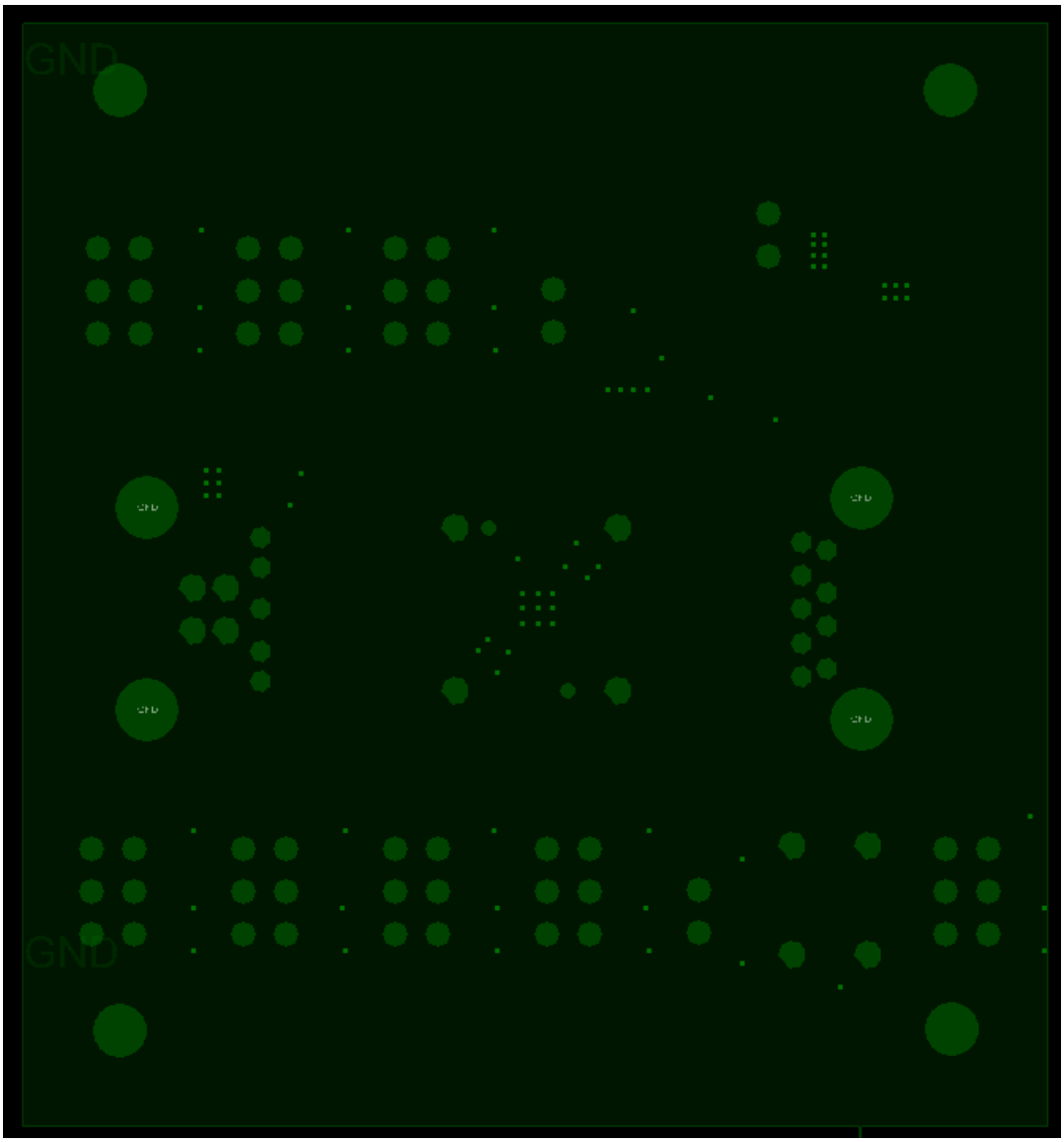


Figure 6. EVM Layout Layer 2 (GND)

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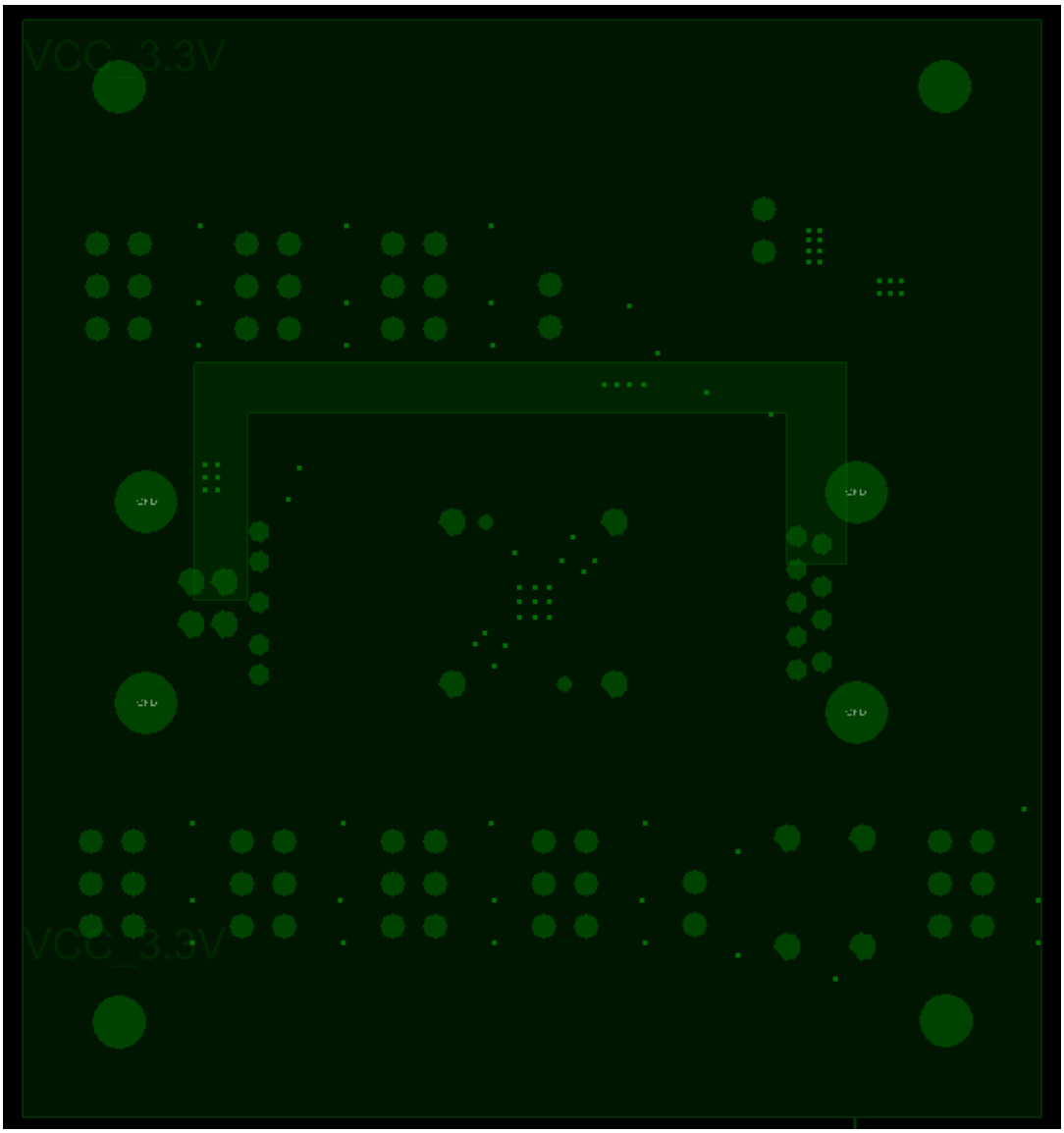


Figure 7. EVM Layout Layer 3 (VCC)

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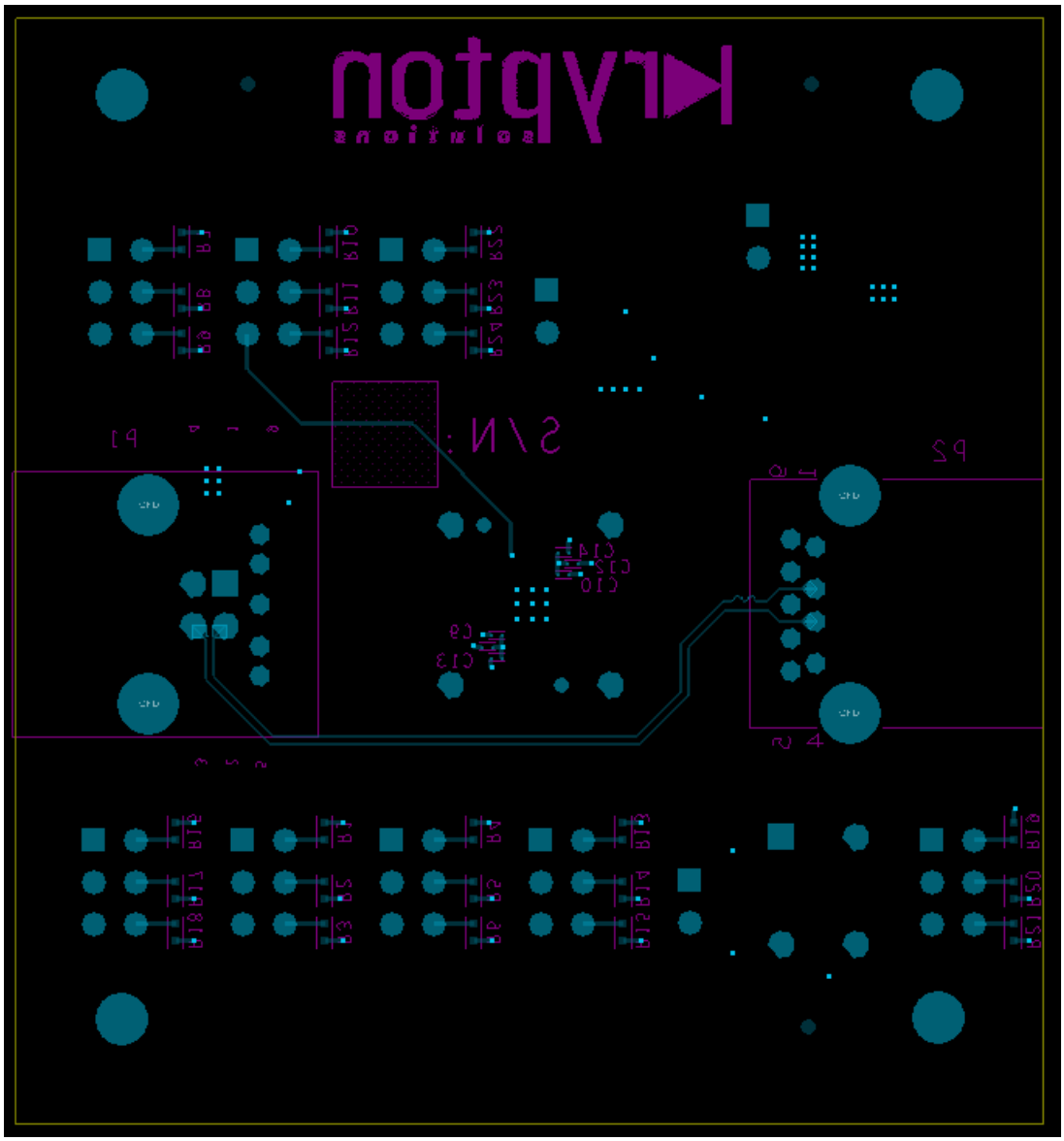


Figure 8. EVM Layout Layer 4 (Bottom)

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4 EVM Material Listing

Table 5 is the complete BOM for the TUSB522P EVM.

Table 5. Bill of Materials

Item	Qty	Reference	Part
1	6	C1,C2,C3,C4,C11,C12	0.1uF
2	2	C5,C6	10uF
3	4	C7,C8,C9,C10	1uF
4	2	C13,C14	0.01uF
5	1	C15	22uF
6	1	C16	.22uF
7	1	D1	LED Green 0805
8	8	J1,J2,J3,J4,J5,J6,J7,J8	HDR3X2 .1X.1
9	3	J9,J10,J11	HDR2X1 M .1
10	1	P1	USB3.0 Type B Receptacle
11	1	P2	USB3 Type A Receptacle
12	17	R1,R3,R4,R6,R7,R9,R10,R12,R13,R15,R16,R18,R19, R21,R22, R24,R25	1k
13	8	R2,R5,R8,R11,R14,R17,R20,R23	20k
14	1	R26	0 Ohm
15	1	R27	10k - NO POP
16	1	R28	300 Ohm
17	1	SW1	Switch - Push Button
18	1	U1	TUSB522PRGE
19	1	U2	LP5907

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      3.1.1 *Notice applicable to EVMs not FCC-Approved:*

      This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

      3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

      CAUTION

      This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

      Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

      FCC Interference Statement for Class A EVM devices

      NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- *Reorient or relocate the receiving antenna.*
- *Increase the separation between the equipment and receiver.*
- *Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- *Consult the dealer or an experienced radio/TV technician for help.*

3.2 *Canada*

3.2.1 *For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210*

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

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2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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